

PATENT

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

I hereby certify that this paper Applicants: Jeun et al. is being deposited with the Serial No.: 09/677,558 United States Postal Service with sufficient postage as first Filed: September 29, 2000 class mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. For: SEMICONDUCTOR POWER 20231 on this date: MODULE HAVING AN ELECTRICALLY INSULATING HEAT SINK AND METHOD OF MANUFACTURING THE December 19, 2000 SAME Attorney Docket No.: 29347/990488 Group Art Unit: 2811 Registration No. 28,491 Attorney for Applicants Examiner: Not yet assigned

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents Washington, D.C. 20231

Sir:

The patent listed on the enclosed PTO Form-1449 is submitted pursuant to 37 CFR §§ 1.56, 1.97, and 1.98. A copy of the patent is enclosed.

This information disclosure statement is being filed within three months of the filing date of the application. In accordance with 37 CFR §1.97(b), no certification or fee is required.

The Commissioner is authorized to charge any fee deficiency required by this paper, or credit any overpayment, to Deposit Account No. 13-2855. A copy of this paper is enclosed.

Respectfully submitted,

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December 19, 2000